



Vishay Vitramon

ROHS

HALOGEN

FREE GREEN (5-2008)

Surface Mount Multilayer Ceramic Chip Capacitors for Electro Static Discharge (ESD) Sensitive Automotive Applications



FEATURES

- AEC-Q200 qualified with PPAP available
- Meets ESD AEC-Q200-002B level 6
- Selective values meet IEC 61000-4-2 level 3 and level 4
- Available in 0603 to 1206 body size
- 100 % matte tin termination for soldering process
- High operating temperature
- · Wet build process
- Reliable Noble Metal Electrode (NME) system
- · Parts compliant with ELV directive
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

For more than 30 years Vishay Vitramon has supported the automotive industry with robust, highly reliable MLCCs that have made it a leader in this segment. All Vishay Vitramon MLCCs are manufactured in "Precious Metal Technology" (PMT / NME) and a wet build process. They are qualified according to AEC-Q200 with PPAP available on request. Applications for these devices include automotive "under the hood", safety and comfort electronics.

X7R DIELECTRIC

GENERAL SPECIFICATION

Note

Electrical characteristics at +25 °C unless otherwise specified

Operating Temperature: -55 °C to +150 °C

(X7R above +125 °C changed characteristics, see 2.2)

Capacitance Range: 1.0 nF to 1.0 µF

Voltage Range: 25 V_{DC} to 200 V_{DC}

Temperature Coefficient of Capacitance (TCC):

± 15 % from -55 °C to +125 °C, with 0 V_{DC} applied

Dissipation Factor (DF):

2.5 % maximum at 1.0 V_{RMS} and 1 kHz

Insulating Resistance:

at +25 °C 100 000 M Ω min. or 1000 Ω F whichever is less at +125 °C 10 000 M Ω min. or 100 Ω F whichever is less

Aging Rate: 1 % maximum per decade

Dielectric Strength Test:

performed per method 103 of EIA 198-2-E.

Applied test voltages

 \leq 250 V_{DC}-rated: 250 % of rated voltage

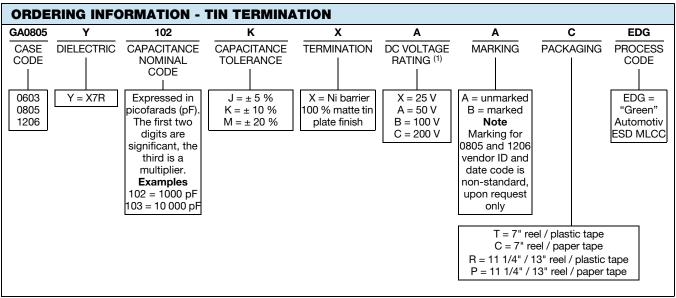
Revision: 31-Jul-2024 **1** Document Number: 45246

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QUICK REFERENCE DATA					
DIEL ECTRIC	CASE CODE	MAXIMUM VOLTAGE CAPAC		ITANCE	
DIELECTRIC	CASE CODE	(V)	MINIMUM	MAXIMUM	
	0603	100	1.0 nF	100 nF	
X7R	0805	200	1.0 nF	150 nF	
	1206	200	10 nF	1.0 μF	

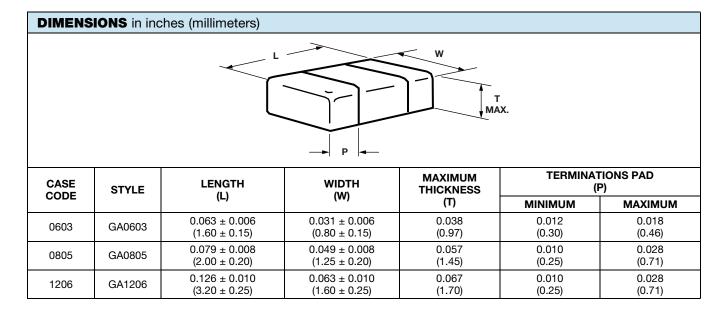
Note

· Detail ratings see "Selection Chart"



Note

(1) DC voltage rating should not be exceeded in application. Other application factors may affect the MLCC performance. Consult for questions: mlcc@vishay.com



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SELECTIO	N CHAR	Т								
DIELECTRIC						X7R				
STYLE		GA06	603 ⁽¹⁾		GA0805 (1)			GA12	206 ⁽¹⁾	
CASE CODE		06	03		0805			12	:06	
VOLTAGE (VD	c)	50	100	50	100	200	25	50	100	200
VOLTAGE CO	DE	Α	В	Α	В	С	X	Α	В	С
CAP. CODE	CAP.									
121	120 pF									
151	150 pF									
181	180 pF									
221	220 pF									
271	270 pF									
331	330 pF									
391	390 pF									
471	470 pF									
561	560 pF									
681	680 pF									
821	820 pF		44 - 4-1			(
102	1.0 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I3)	• (A6, I3)	• (A6, I3)				
152	1.5 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I3)	• (A6, I3)	• (A6, I3)				
182	1.8 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I3)	• (A6, I3)	• (A6, I3)				
222	2.2 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I3)	• (A6, I3)	• (A6, I3)				
272	2.7 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I4)	• (A6, I4)	• (A6, I4)				
332	3.3 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I4)	• (A6, I4)	• (A6, I4)				
472	4.7 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I4)	• (A6, I4)	• (A6, I4)				
562	5.6 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I4)	• (A6, I4)	• (A6, I4)				
682	6.8 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I4)	• (A6, I4)	• (A6, I4)				
822	8.2 nF	•• (A6, I3)	•• (A6, I3)	• (A6, I4)	• (A6, I4)	• (A6, I4)			(4.5.14)	(4.0.1.1)
103	10 nF	•• (A6, I4)	•• (A6, I4)	•• (A6, I3)	•• (A6, I3)	•• (A6, I3)			• (A6, I4)	• (A6, I4)
153	15 nF	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	• (A6, I4)			• (A6, I4)	• (A6, I4)
183	18 nF	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	• (A6, I4)			• (A6, I4)	• (A6, I4)
223	22 nF	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	• (A6, I4)			• (A6, I4)	• (A6, I4)
273	27 nF	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)				• (A6, I4)	• (A6, I4)
333	33 nF	•• (A6, I4)	•• (A6, I4)	•• (A6, I4)	• (A6, I4)		ļ		• (A6, I4)	• (A6, I4)
393	39 nF	•• (A6, I4)		•• (A6, I4)	• (A6, I4)				• (A6, I4)	• (A6, I4)
473	47 nF	•• (A6, I4)		•• (A6, I4)	• (A6, I4)				• (A6, I4)	• (A6, I4)
683	68 nF	•• (A6, I4)		• (A6, I4)	• (A6, I4)				• (A6, I4)	• (A6, I4)
104 124	100 nF	•• (A6, I4)		• (A6, I4)	• (A6, I4)				• (A6, I4)	• (A6, I4)
154	120 nF 150 nF			• (A6, I4)					• (A6, I4) • (A6, I4)	
224	220 nF			• (A6, I4)				• (AG 14)		
274	270 nF							• (A6, I4) • (A6, I4)	• (A6, I4)	
334	330 nF	-						• (A6, I4)		
474	470 nF			-			-	• (A6, I4)		
105	470 HF 1.0 μF						• (A6, I4)	· (A0, 14)		
125	1.0 µF			-			· (A0, 14)			
155	1.2 µF			 	1		 			
185	1.8 µF			 	1		 			
225	2.2 µF									
275	2.2 µr 2.7 µF									
335	3.3 µF									
395	3.9 µF	-								
475	4.7 μF	-								
565	4.7 μl 5.6 μF	-								
685	6.8 μF	1		 	 		 			

Notes

- •• Paper tape Plastic tape
- (1) See soldering recommendations within this data book, or visit www.vishay.com/doc?45034
- A6: AEC-Q200 level 6 I3: IEC 61000-4-2 level 3
 - I4: IEC 61000-4-2 level 4



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STANDAR	STANDARD PACKAGING QUANTITIES (1)(2)					
		7" REEL QUANTITIES		11 1/4" AND 13" REEL QUANTITIES		
CASE CODE	TAPE SIZE	PAPER TAPE PACKAGING CODE "C"	PLASTIC TAPE PACKAGING CODE "T"	PAPER TAPE PACKAGING CODE "P"	PLASTIC TAPE PACKAGING CODE "R"	
0603	8 mm	4000	4000	10 000	10 000	
0805	8 mm	3000	3000	10 000	10 000	
1206 ⁽³⁾	8 mm	n/a	2500 / 3000	n/a	10 000	

Notes

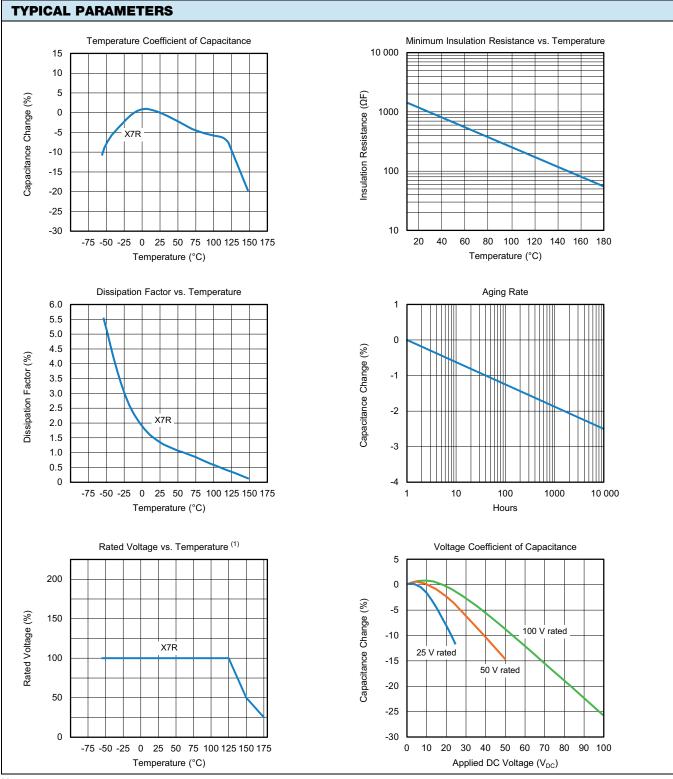
⁽¹⁾ Reference: EIA standard RS 481 - "Taping of Surface Mount Components for Automatic Placement"

⁽²⁾ n/a = not available

⁽³⁾ Lower packaging quantity can depend from product thickness



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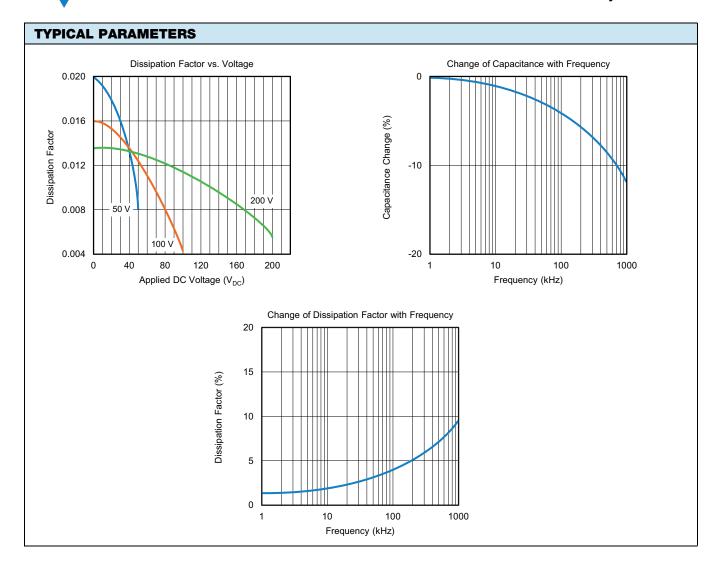
Note

⁽¹⁾ Except for GA0603Y104*A (100 nF / 50 V), see section "2.2 Characteristics"





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1 - GENERAL CERTIFICATES

# Quality management system according to ISO/IATF 16949: 2016	Yes
# Quality management system according to ISO 9001: 2015	Yes
# Environmental certification according to ISO 14001: 2015	Yes
# Health and safety system according to OHSAS 18001	Yes

2 - TECHNICAL REQUIREMENTS

Unless specified in component specification, these parameters are the minimum requirements for the components.

2.1 OPERATING TEMPERATURE RANGE

For standard applications	T _A : -55 °C to +125 °C	See characteristics 2.2
For high temperature applications	T _A : -55 °C to +150 °C	See characteristics 2.2
For ultra high temperature applications	T _A : -55 °C to +175 °C	See characteristics 2.2

2.2 CHARACTERISTICS

PARAMETER	CERAMIC TYPE	SYMBOL	RATINGS	TEST CONDITIONS / REMARKS
Rated voltage in temperature range -55 °C to +125 °C			25 V to 200 V	
Derating at higher temperature up to +150 °C	X7R	U _R	25 V to 100 V	$U_{DC} \le {}^{1}/_{2} U_{R}$ $U_{DC} \le {}^{1}/_{4} U_{R}$ for GA0603Y104*A (100 nF / 50 V)
Derating at higher temperature up to +175 °C			25 V to 100 V	$U_{DC} \le \frac{1}{4} U_{R}$
Temperature coefficient in temperature range -55 °C to +125 °C			≤ ± 15 %	
Temperature coefficient in temperature range -55 °C to +150 °C	X7R	ΔC	+ 15 % / - 30 %	
Temperature coefficient in temperature range -55 °C to +175 °C			+ 15 % / - 50 %	
Dissipation factor in temperature range -55 °C to +175 °C	X7R	tan δ	≤ 0.06	

2.3 STORAGE AND HANDLING CONDITIONS

- (1) Store the components at 5 °C to 40 °C ambient temperature and ≤ 70 % relative humidity conditions.
- (2) The product is recommended to be used within a time-frame of 2 years after shipment. Check solderability in case extended shelf life beyond the expiry date is needed.

Precautions:

- a. Do not store products in an environment containing corrosive elements, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. This may cause corrosion or oxidization of the terminations, which can easily lead to poor soldering.
- b. Store products on the shelf and avoid exposure to moisture or dust.
- c. Do not expose products to excessive shock, vibration, direct sunlight and so on.



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3 - LOT ACCEPTANCE TESTS

Process tests available in classes (on request)

GROUP	ACTION
A	Components are tested within the monitoring program of the supplier. The supplier shall submit the part numbers of the selected component to the customer during the component specification discussions.
В	Components (customer P/N) shall be tested quarterly. Records available only on special request by the customer.
С	Test with each shipment. Records are provided on a monthly basis. Customer special requirement; requirement should be determined in a specific component specification.

Upon request the records can be submitted in electronic format on monthly basis.

3.1 THERMAL STRENGTH, THERMAL SHOCK SENSIBILITY

Sample size	200
Handling	Mounted on PCB
Thermal shock	1 x 280 °C, no pre-heat, 5 s to 10 s
IR - test (IRATS) $U = U_R$, $T = room$ temperature, verified	
Burn in (BIATS)	Equivalent to 12 h burn-in, 2 x U _R /125 °C, verification time to failure

Acceptance criteria: zero defects (IRATS and BIATS).

3.2 BOARD FLEX TEST

Sample size	20 pcs/lot	
Frequency	At least three different part numbers of one component family matrix per quarter	
Max. deflection	8 mm (data to be reported, available on request)	

3.3 SOLDERABILITY / RESISTANCE TO SOLDERING HEAT

Temperature profile for reflow soldering of SMD parts IPC/JEDEC-J-STD-020C.

Test is done on a regular basis for samples taken randomly out of the line.

Acceptance criteria: at least 95 % new solder and no detachment or leaching of terminations.

4 - ENVIRONMENTAL REQUIREMENTS

A list of the chemical substances content, which must not be used or whose use shall be limited by international law, is available on request.

Vishay confirms that the components specified in this specification do not contain asbestos nor cadmium, not even in the smallest volumes.

The manufacturer / supplier confirms that the component during normal handling, storage and assembly, as well as during operation in the automobile, is non toxic.



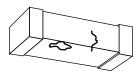
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5 - INSPECTION CRITERIA

The supplier shall carry out visual examination with suitable equipment with approximately 10 x magnification and lighting appropriate to the specimen under test and the required quality level.

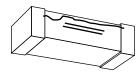
Chipping

The components shall be free of cracks or fissures. Small damages which do not deteriorate the performance of the component as defined in EIA 595.



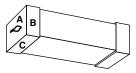
Delamination or Exposed Electrodes

No visible separation or delamination between layers of the capacitor and no exposed electrodes between the two terminals of the capacitor must be seen.



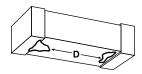
Metallization

For the metallization, no visible detachment of the metallized terminals and no exposed electrodes must be seen. Defects and gaps in the metallization on each sides of the terminal must not exceed 10 % of the total area (e.g. A, B, C, ...) as defined in EIA 595. Leaching shall not exceed 25 %.



Electrode Distance

The ceramic body shall be free of any conducting material between the terminals which reduces the distance of the electrodes. The minimum distance "D" is 400 µm for all package sizes.





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6 - BOARD FLEX TEST CONDITIONS

6.1 BOARD FLEX DEFINITIONS OF TEST

PCB thickness = (1.6 ± 0.1) mm

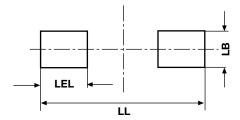
Copper thickness = 35 µm

Material FR4 (EP-GC 02 according to DIN 40 802)

LAYOUT / PAD DESIGN (Dimensions in mm)			
CASE CODE		PAD SIZE	
CASE CODE	LL	LB	LEL
0603	2.20	1.00	0.75
0805	3.40	1.30	1.20
1206	4.50	1.80	1.20

Note

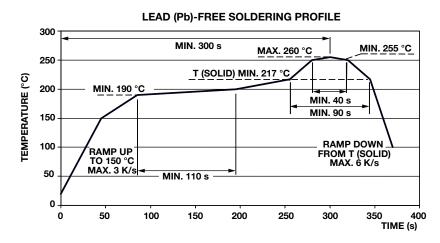
• LL = total length; LB = width of the pad; LEL = single pad length



6.2 SOLDERING INSTRUCTIONS

THICKNESS, RECOMMENDED FOR SOLDER PASTE (Reflow soldering)			
CASE CODE	THICKNESS in μm		
0603	150 to 200		
0805	150 to 200		
1206	150 to 200		

6.3 TYPICAL TEMPERATURE PROFILE FOR REFLOW SOLDERING (Board flex test)

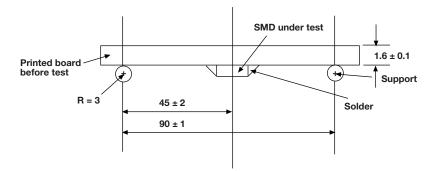




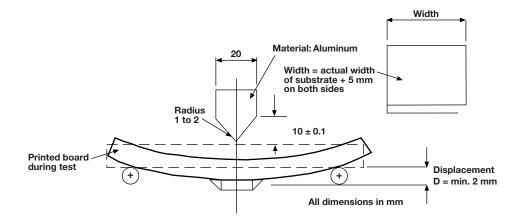
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6.4 MOUNTING, DIMENSIONS, AND TESTING

Mounting



Testing



6.5 PERFORMANCE OF THE TEST(S)

- A) Electrical test according to component specification (Cap, DF, IR)
- B) Mounting to PCB
- C) Storage at room temperature (min. 10 h)
- D) Board flex test

6.6 DETAILS

X7R	PCB to be deflected continuously, speed 1 mm/s (± 0.5 mm/s)
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6.7 FAILURE CRITERIA

X7R	Piezoelectric sensor, no failure up to min. 2 mm Electrical test according to component specification
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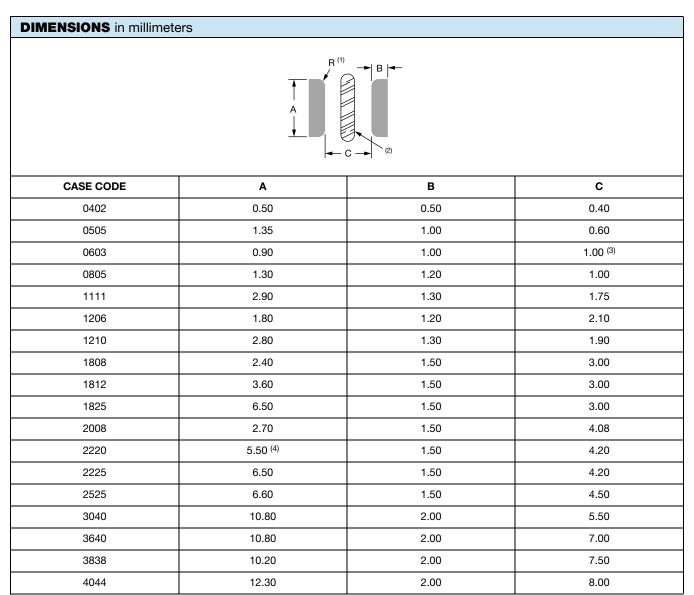
7 - AEC-Q200 QUALIFICATION TESTING

NO.	AEC-Q200 TEST ITEM	REFERENCE
1	Pre- and post stress electrical test	User spec
3	High temp exposure (storage)	MIL-STD-202, method 108
4	Temperature cycling	JESD22, method JA-104
5	Destructive physical analysis	EIA-469
6	Moisture resistance	MIL-STD-202, method 106
7	Biased humidity	MIL-STD-202, method 103
8	Operation life	MIL-STD-202 method 108
9	External Visual	MIL-STD-883 method 2009
10	Physical dimension	JESD22, method JB-100
13	Mechanical shock	MIL-STD-202, method 213
14	Vibration	MIL-STD-202, method 204
15	Resistance to solder heat	MIL-STD-202, method 210
16	ESD	AEC-Q200-002
17	Solderability	J-STD-002
20	Electrical characterization	User spec
21	Board flex	AEC-Q200-005
22	Terminal strength	AEC-Q200-006
23	Beam load	AEC-Q200-003



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Solder Pad Dimensions for Vishay Surface-Mount Multilayer Ceramic Chip Capacitors



Notes

⁽¹⁾ For safety capacitors and voltages above 3000 V, corner rounding (R) of 0.5 mm is recommended to suppress arcing

⁽²⁾ Add a 1 mm slot in PCB between pads to allow cleaning and coating under MLCC

⁽³⁾ For VJ HiFREQ Series, this dimension is 0.6 mm

⁽⁴⁾ For safety capacitors, the A dimension should be 5.80 mm

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Guidelines for MLCC Solder Pads and PCBs

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PRINTED CIRCUIT BOARD PCB DESIGN CONSIDERATIONS FOR HIGH VOLTAGE SURFACE-MOUNT MLCCS

Special assembly process and design considerations should be employed for today's high voltage rating MLCCs. As case sizes remain the same and voltage ratings increase, MLCC manufacturers must design, evaluate, and qualify their capacitors using methods that reduce the occurrence of corona discharge and arcover events. To meet similar capability in high voltage applications, users should employ similar cautionary design and assembly methods.

MLCC PAD LAYOUT

A capacitor's arcover inception point can degrade due to factors such as the MLCC termination, PCB pad design, PCB cleanliness, solder flux residue, surface contamination / deposits and environmental conditions. PCB pads and their design affect the air gap distance between the opposing polarities of the MLCC termination. For voltage rating greater than 1500 V_{DC} add a corner radius to the inward facing edge of the MLCC pads and as large a gap as possible between the pads. Too small of a pad gap distance will reduce the capacitor's own arcover inception voltage level. Refer to the Figure and Table Figure 1.0, MLCC Pad Layout and Table 1.0, Vishay MLCC Solder Pad Dimensions for the recommended MLCC solder pad dimensions.

SLOT OR TRENCH BETWEEN PADS

PCB assembly can deposit dust, trap solder balls, or flux residue underneath the capacitors. These contaminants will reduce conductive clearances and the arcover inception level. Assembly methods must include a final PCB cleaning process. A slot or trench can be cut into the PCB in between the pads to allow cleaners to penetrate underneath the MLCC. The slot will also allow conformal or epoxy coatings to flow underneath the MLCC and build an insulative barrier between pads. Refer to Figure 1.0 MLCC Pad Layout for slot reference location.

COATING PRINTED CIRCUIT BOARD

Coating a printed circuit board with materials such as acrylic, silicone and urethane resins provide a protective dielectric barrier that is non-conductive and will enhance the resistance to arcing. Various processes exist which include dipping, brushing, and spaying. Optimal performance will come from coating the MLCC on all sides, top and bottom. The PCB slot in between the pads should extend slightly beyond the width of the MLCC. Refer to Figure 1.0 MLCC Pad Layout for slot reference location.



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